

N-channel 30 V 2.1 m Ω logic level MOSFET

Rev. 01 — 24 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

 High efficiency due to low switching and conduction losses

1.3 Applications

- DC-to-DC converters
- Load switiching

1.4 Quick reference data

 Suitable for logic level gate drive sources

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- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	30	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>	[1]	-	-	100	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	211	W
Dynamic	characteristics						
Q _{GD}	gate-drain charge	V_{GS} = 4.5 V; I _D = 25 A;		-	16	-	nC
Q _{G(tot)}	total gate charge	V _{DS} = 12 V; see <u>Figure 13;</u> see <u>Figure 14</u>		-	55	-	nC
Static ch	aracteristics						
R_{DSon}	drain-source on-state resistance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 15 \text{ A}; \\ T_{j} = 25 \text{ °C} \end{array}$		-	2	2.8	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u>	[2]	-	1.7	2.1	mΩ

[1] Continuous current is limited by package.

[2] Measured 3 mm from package.

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2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S
			SOT78 (TO-220AB)	

3. Ordering information

Table 3.Ordering information

Type number Package			
	Name	Description	Version
PSMN2R0-30PL	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

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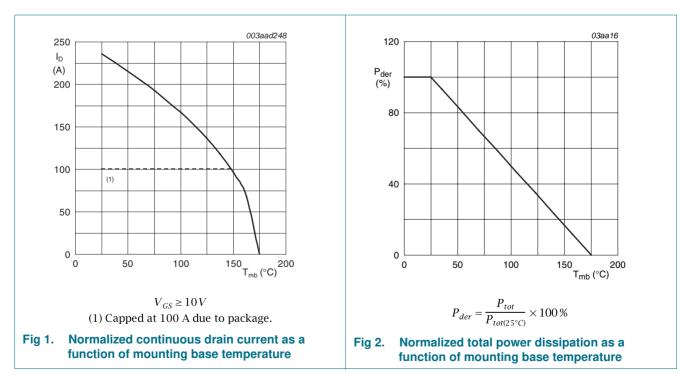
4. Limiting values

Table 4.Limiting values

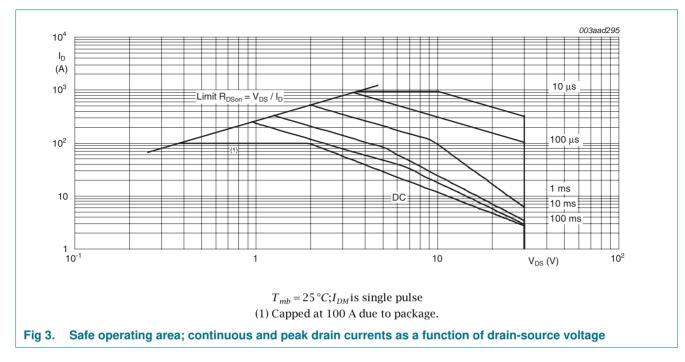
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	30	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	30	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V_{GS} = 10 V; T_{mb} = 100 °C; see <u>Figure 1</u>	[1]	-	100	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3		-	943	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	211	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C	[1]	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	943	А
Avalanche	e ruggedness					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_{D} = 100 A; V_{sup} ≤ 30 V; R_{GS} = 50 $\Omega;$ unclamped		-	555	mJ

[1] Continuous current is limited by package.



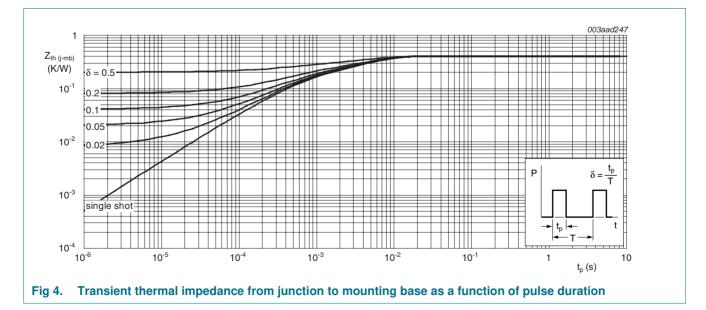
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5. Thermal characteristics

Table 5.	Thermal	characteristics
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	see <u>Figure 4</u>	-	0.41	0.71	K/W



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6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$		30	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$		27	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 9</u> ; see <u>Figure 10</u>		1.3	1.7	2.15	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 10</u>		0.5	-	-	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 10</u>		-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	70	μA
I _{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
		$V_{GS} = -16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 4.5 V; I_{D} = 15 A; T_{j} = 25 °C		-	2	2.8	mΩ
	resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; see <u>Figure 11</u>		-	-	3	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u>	[2]	-	1.7	2.1	mΩ
R _G	gate resistance	f = 1 MHz		-	0.78	-	Ω
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 13</u> ; see <u>Figure 14</u>		-	117	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$ see Figure 13; see Figure 14		-	55	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	17	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 13;</u> see <u>Figure 14</u>		-	11	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	6	-	nC
Q _{GD}	gate-drain charge			-	16	-	nC
V _{GS(pl)}	gate-source plateau voltage	V_{DS} = 12 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	2.6	-	V
C _{iss}	input capacitance	V_{DS} = 12 V; V_{GS} = 0 V; f = 1 MHz;		-	6810	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 15$		-	1410	-	pF
C _{rss}	reverse transfer capacitance			-	650	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_L = 0.5 Ω; V_{GS} = 4.5 V;		-	63	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \ \Omega$		-	125	-	ns
t _{d(off)}	turn-off delay time			-	111	-	ns
t _f	fall time			-	59	-	ns

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	ed					
Parameter	Conditions		Min	Тур	Max	Unit
ain diode						
source-drain voltage	$I_{S} = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C};$ see <u>Figure 16</u>		-	0.76	1.2	V
reverse recovery time		_S = 0 V;	-	49	-	ns
recovered charge	$V_{DS} = 30 V$		-	66	-	nC
to JEDEC standards where a ed 3 mm from package.	oplicable.					
0 0.5 1		80	2		003aad254	
			aracteristic	s: drain		
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	recovered charge to JEDEC standards where an ed 3 mm from package.	reverse recovery time recovered charge to JEDEC standards where applicable. ed 3 mm from package. 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 003aad249 10 003aad249 10 003aad249 10 003aad249 10 003aad249 10 10 10 10 10 10 10 10	reverse recovery time $I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A}/\mu\text{s}$; $V_{GS} = 0 \text{ V}$; recovered charge $V_{DS} = 30 \text{ V}$ to JEDEC standards where applicable. ed 3 mm from package.	reverse recovery time $I_{\rm S} = 20$ A; dIs/dt = -100 A/µs; V _{GS} = 0 V; recovered charge $V_{\rm DS} = 30$ V	reverse recovery time $l_{\rm S} = 20$ A; dl _S /dt = -100 A/µs; V _{GS} = 0 V; - 49 recovered charge $V_{\rm DS} = 30$ V - 66 to JEDEC standards where applicable. ed 3 mm from package.	reverse recovery time $I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A}/\mu\text{s}$; $V_{GS} = 0 \text{ V}$; $-49 - 66 - 66 - 66 - 66 - 66 - 66 - 66 -$

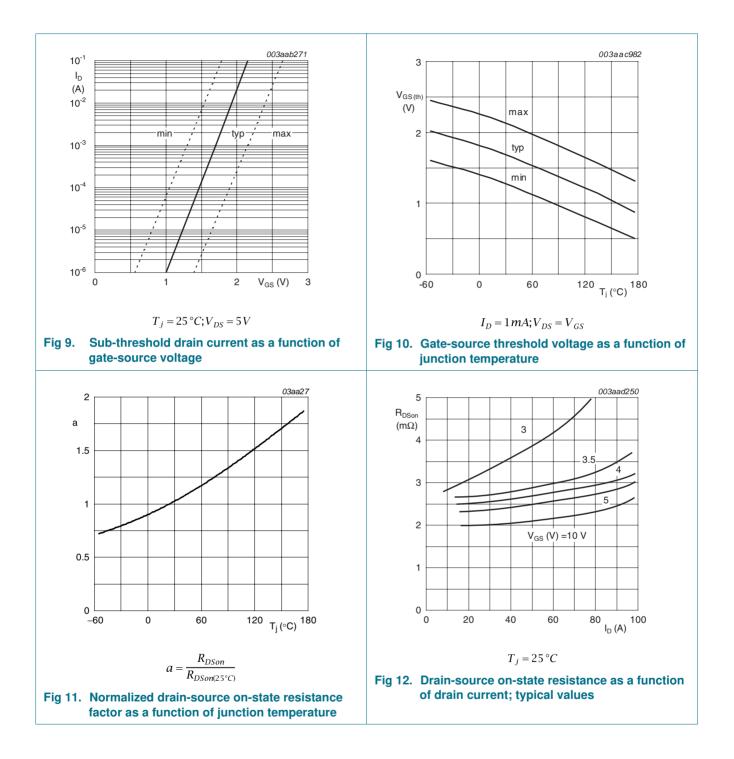
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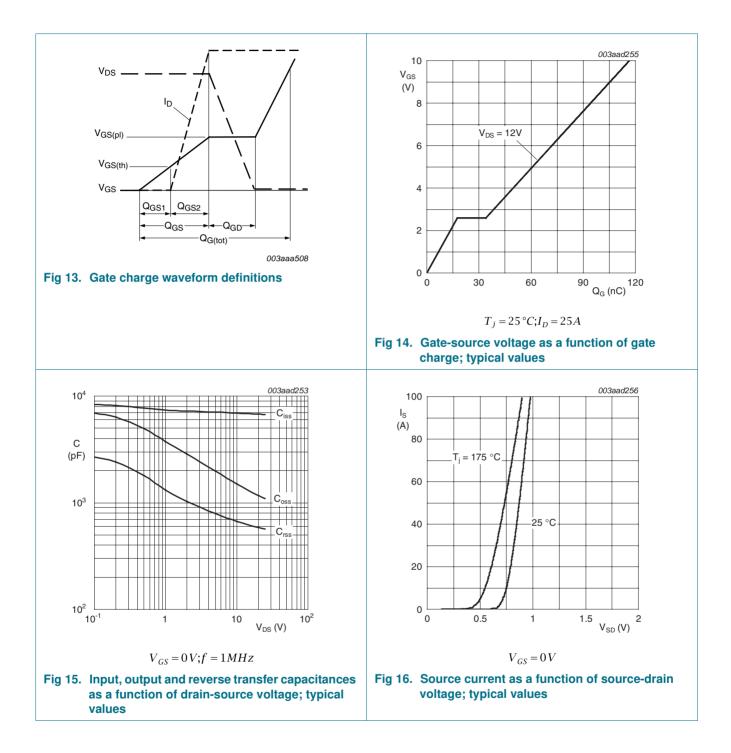
drain current; typical values

of gate-source voltage; typical values

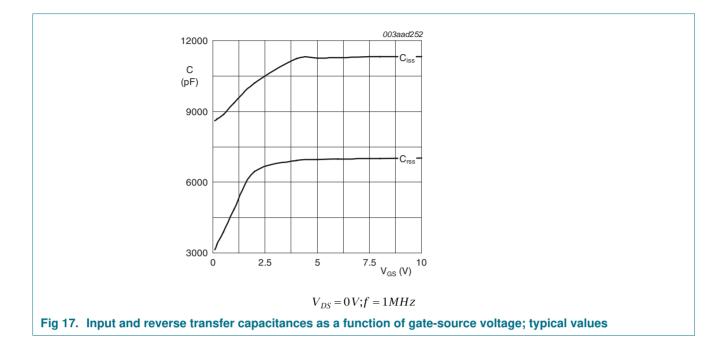
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7. Package outline

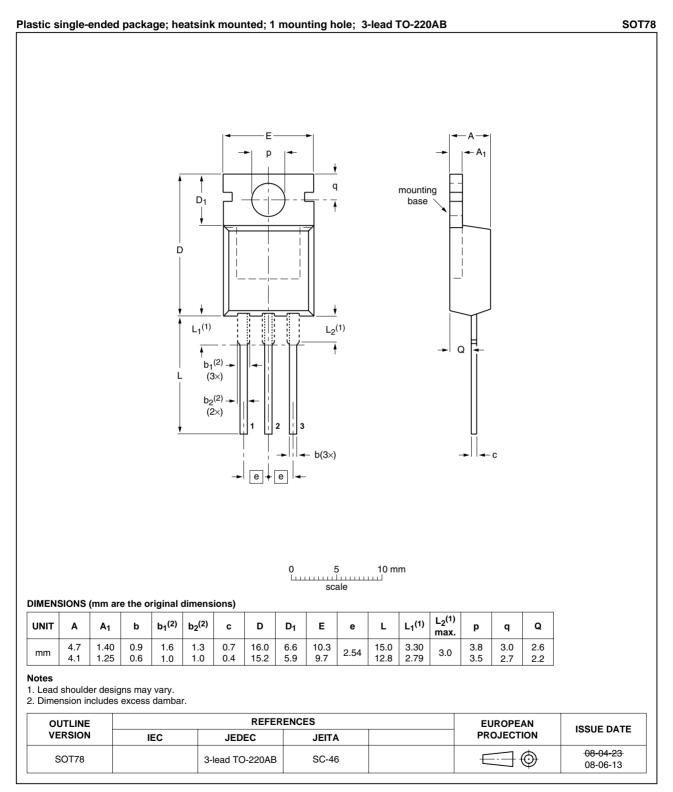


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PSMN2R0-30PL_1	20090624	Product data sheet	-	-		

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9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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